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74HC157D

1. Functional Description

- Quad 2-Channel Multiplexer

2. General

The 74HC157D is high speed CMOS 2-CHANNEL MULTIPLEXER fabricated with silicon gate C²MOS technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

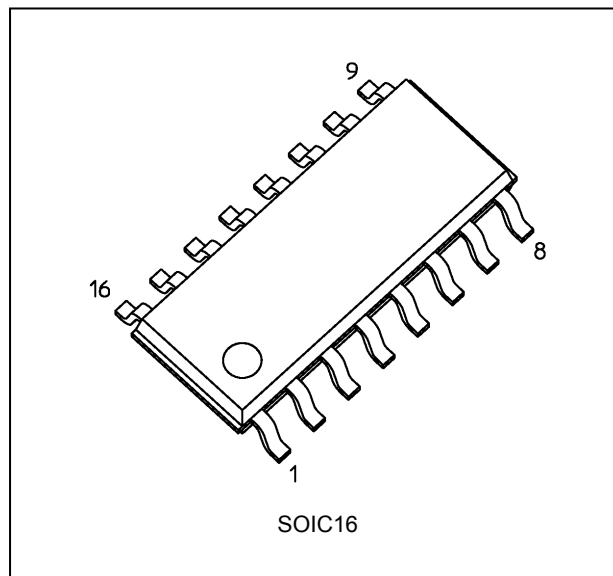
When $\overline{\text{STROBE}}$ is held high, selection of data is inhibited and all the outputs become low .

The SELECT decoding determines whether the A or B inputs get transferred to their corresponding Y outputs. All inputs are equipped with protection circuits against static discharge or transient excess voltage.

3. Features

- (1) High speed: $t_{pd} = 10 \text{ ns}$ (typ.) at $V_{CC} = 5 \text{ V}$
- (2) Low power dissipation: $I_{CC} = 4.0 \mu\text{A}$ (max) at $T_a = 25 \text{ }^\circ\text{C}$
- (3) Balanced propagation delays: $t_{PLH} \approx t_{PHL}$
- (4) Wide operating voltage range: $V_{CC(\text{opr})} = 2.0 \text{ to } 6.0 \text{ V}$

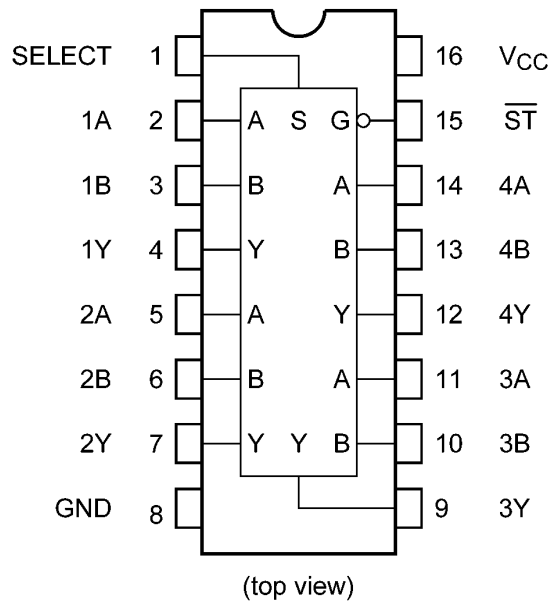
4. Packaging



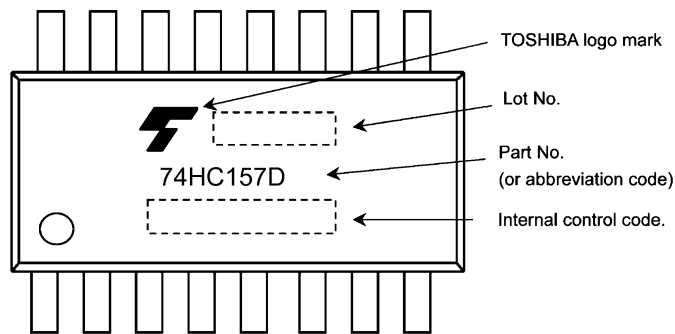
Start of commercial production

2016-05

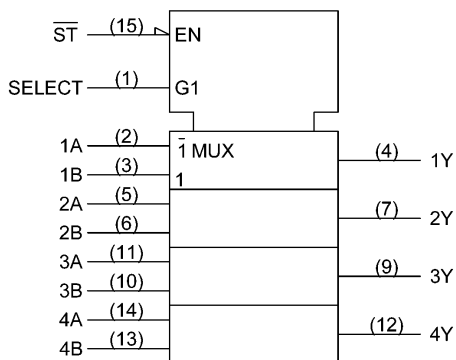
5. Pin Assignment



6. Marking



7. IEC Logic Symbol

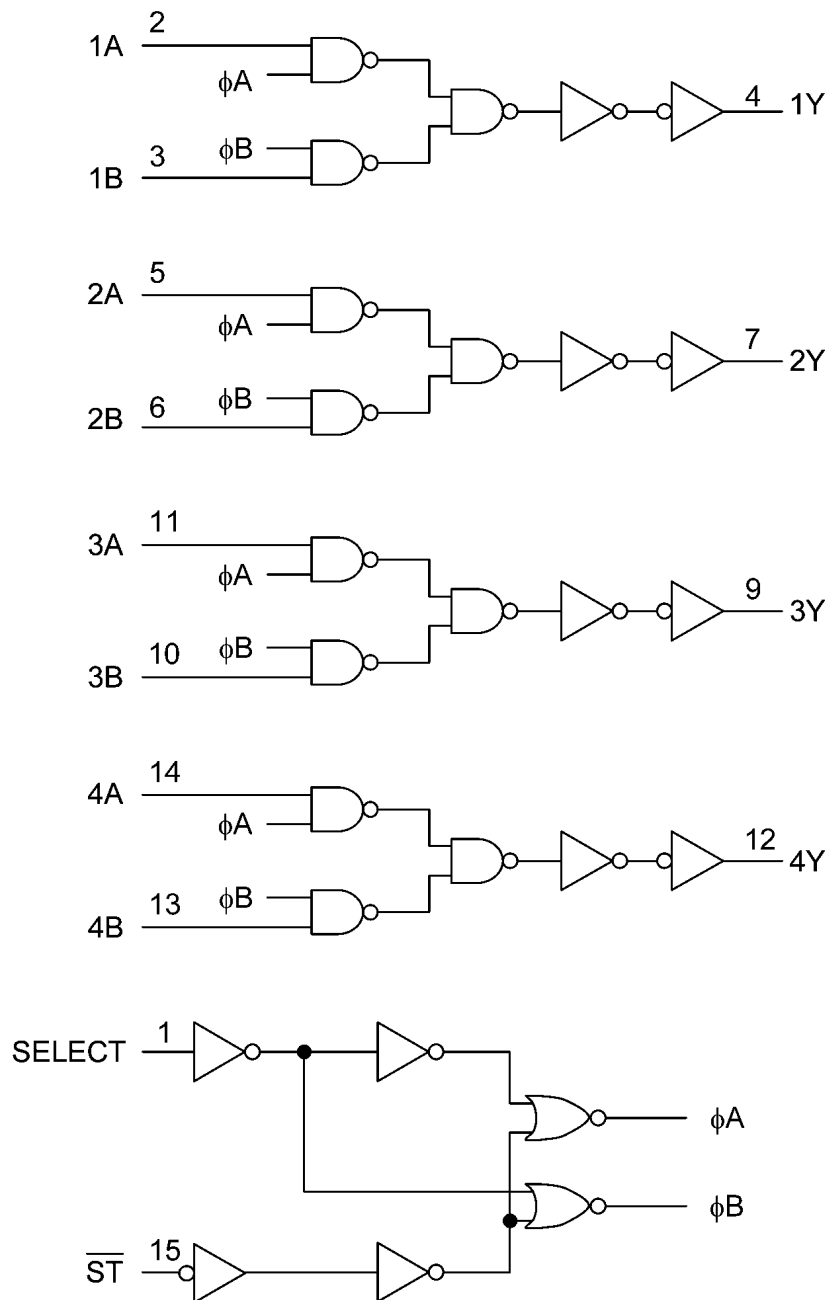


8. Truth table

\overline{ST}	SELECT	A	B	OUTPUT
H	X	X	X	L
L	L	L	X	L
L	L	H	X	H
L	H	X	L	L
L	H	X	H	H

X: Don't care

9. System Diagram



10. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V_{CC}	-0.5 to 7.0	V
Input voltage	V_{IN}	-0.5 to $V_{CC} + 0.5$	
Output voltage	V_{OUT}	-0.5 to $V_{CC} + 0.5$	
Input diode current	I_{IK}	± 20	mA
Output diode current	I_{OK}	± 20	
Output current	I_{OUT}	± 25	
V_{CC} /ground current	I_{CC}	± 50	
Power dissipation	P_D	500	mW
Storage temperature	T_{stg}	-65 to 150	$^{\circ}C$

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/“Derating Concept and Methods”) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

11. Operating Ranges (Note)

Characteristics	Symbol	Test Condition	Rating	Unit
Supply voltage	V_{CC}		2.0 to 6.0	V
Input voltage	V_{IN}		0 to V_{CC}	
Output voltage	V_{OUT}		0 to V_{CC}	
Operating temperature	T_{opr}		-40 to 85	$^{\circ}C$
Input rise and fall times	t_r, t_f	$V_{CC} = 2.0\text{ V}$	0 to 1000	ns
		$V_{CC} = 4.5\text{ V}$	0 to 500	
		$V_{CC} = 6.0\text{ V}$	0 to 400	

Note: The operating ranges are required to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.

12. Electrical Characteristics

12.1. DC Characteristics (Unless otherwise specified, $T_a = 25\text{ }^\circ\text{C}$)

Characteristics	Symbol	Test Condition	V_{CC} (V)	Min	Typ.	Max	Unit	
High-level input voltage	V_{IH}	—	2.0	1.50	—	—	V	
			4.5	3.15	—	—		
			6.0	4.20	—	—		
Low-level input voltage	V_{IL}	—	2.0	—	—	0.50	V	
			4.5	—	—	1.35		
			6.0	—	—	1.80		
High-level output voltage	V_{OH}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OH} = -20\text{ }\mu\text{A}$	2.0	1.9	2.0	—	V
				4.5	4.4	4.5	—	
			$I_{OH} = -4\text{ mA}$	6.0	5.9	6.0	—	
				4.5	4.18	4.31	—	
Low-level output voltage	V_{OL}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OL} = 20\text{ }\mu\text{A}$	2.0	—	0.0	0.1	V
				4.5	—	0.0	0.1	
				6.0	—	0.0	0.1	
			$I_{OL} = 4\text{ mA}$	4.5	—	0.17	0.26	
				6.0	—	0.18	0.26	
Input leakage current	I_{IN}	$V_{IN} = V_{CC}$ or GND	6.0	—	—	± 0.1	μA	
Quiescent supply current	I_{CC}	$V_{IN} = V_{CC}$ or GND	6.0	—	—	4.0	μA	

12.2. DC Characteristics (Unless otherwise specified, $T_a = -40$ to $85\text{ }^\circ\text{C}$)

Characteristics	Symbol	Test Condition	V_{CC} (V)	Min	Max	Unit	
High-level input voltage	V_{IH}	—	2.0	1.50	—	V	
			4.5	3.15	—		
			6.0	4.20	—		
Low-level input voltage	V_{IL}	—	2.0	—	0.50	V	
			4.5	—	1.35		
			6.0	—	1.80		
High-level output voltage	V_{OH}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OH} = -20\text{ }\mu\text{A}$	2.0	1.9	—	V
				4.5	4.4	—	
			$I_{OH} = -4\text{ mA}$	6.0	5.9	—	
				4.5	4.13	—	
Low-level output voltage	V_{OL}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OL} = 20\text{ }\mu\text{A}$	2.0	—	0.1	V
				4.5	—	0.1	
				6.0	—	0.1	
			$I_{OL} = 4\text{ mA}$	4.5	—	0.33	
				6.0	—	0.33	
Input leakage current	I_{IN}	$V_{IN} = V_{CC}$ or GND	6.0	—	± 1.0	μA	
Quiescent supply current	I_{CC}	$V_{IN} = V_{CC}$ or GND	6.0	—	40.0	μA	

12.3. AC Characteristics

(Unless otherwise specified, $C_L = 15 \text{ pF}$, $V_{CC} = 5 \text{ V}$, $T_a = 25 \text{ }^\circ\text{C}$, Input: $t_r = t_f = 6 \text{ ns}$)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Output transition time	t_{TLH}, t_{THL}	—	—	4	8	ns
Propagation delay time (A, B - Y)	t_{PLH}, t_{PHL}	—	—	10	16	ns
Propagation delay time (SELECT - Y)	t_{PLH}, t_{PHL}	—	—	13	21	ns
Propagation delay time (\overline{ST} - Y)	t_{PLH}, t_{PHL}	—	—	10	19	ns

12.4. AC Characteristics

(Unless otherwise specified, $C_L = 50\text{pF}$, $T_a = 25 \text{ }^\circ\text{C}$, Input: $t_r = t_f = 6 \text{ ns}$)

Characteristics	Symbol	Note	V_{CC} (V)	Min	Typ.	Max	Unit
Output transition time	t_{TLH}, t_{THL}		2.0	—	30	75	ns
			4.5	—	8	15	
			6.0	—	7	13	
Propagation delay time (A, B - Y)	t_{PLH}, t_{PHL}		2.0	—	36	100	ns
			4.5	—	12	20	
			6.0	—	10	17	
Propagation delay time (SELECT - Y)	t_{PLH}, t_{PHL}		2.0	—	50	125	ns
			4.5	—	16	25	
			6.0	—	14	21	
Propagation delay time (\overline{ST} - Y)	t_{PLH}, t_{PHL}		2.0	—	36	115	ns
			4.5	—	12	23	
			6.0	—	10	20	
Input capacitance	C_{IN}		—	—	5	—	pF
Power dissipation capacitance	C_{PD}	(Note 1)	—	—	57	—	pF

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.

$$I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/4 \text{ (per bit)}$$

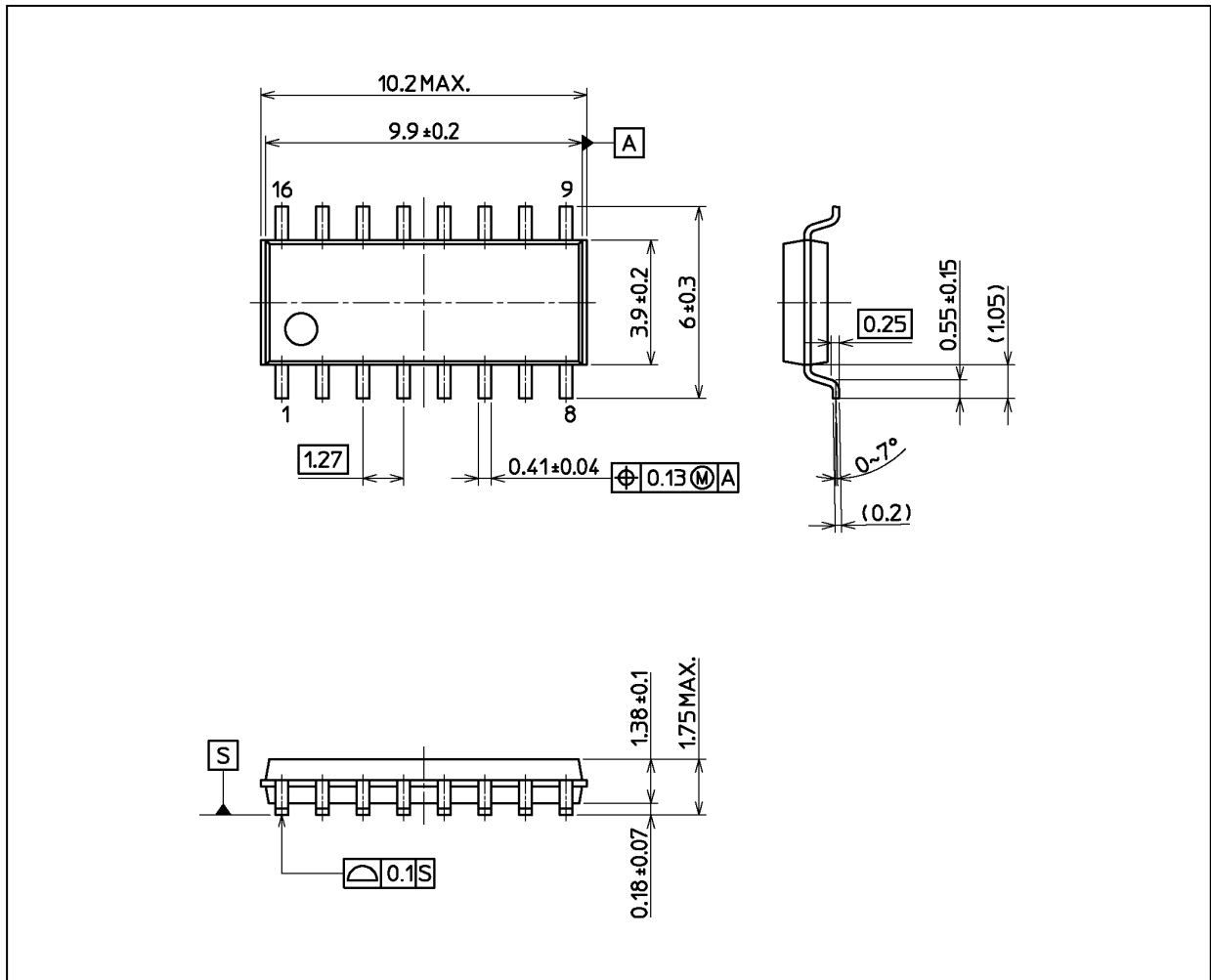
12.5. AC Characteristics

(Unless otherwise specified, $C_L = 50 \text{ pF}$, $T_a = -40 \text{ to } 85 \text{ }^\circ\text{C}$, Input: $t_r = t_f = 6 \text{ ns}$)

Characteristics	Symbol	V_{CC} (V)	Min	Max	Unit
Output transition time	t_{TLH}, t_{THL}	2.0	—	95	ns
		4.5	—	19	
		6.0	—	16	
Propagation delay time (A, B - Y)	t_{PLH}, t_{PHL}	2.0	—	125	ns
		4.5	—	25	
		6.0	—	21	
Propagation delay time (SELECT - Y)	t_{PLH}, t_{PHL}	2.0	—	155	ns
		4.5	—	31	
		6.0	—	26	
Propagation delay time (\overline{ST} - Y)	t_{PLH}, t_{PHL}	2.0	—	145	ns
		4.5	—	29	
		6.0	—	25	

Package Dimensions

Unit: mm



Weight: 0.15 g (typ.)

Package Name(s)
Nickname: SOIC16

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